# BUSSMANN SERIES

# **AHCA-BM**

# Automotive high voltage 6.3 mm x 32 mm fast-acting fuse



#### **Product features**

- · High voltage ceramic tube fuse
- Compact 3AB 6.3 mm x 32 mm (¼" x 1 ¼") fuse
- Fast-acting performance
- 450 Vac rating
- PCB terminal mount
- Very high interrupting ratings to help safely protect against dangerous high fault currents

#### **Applications**

- On-board power conversion (Inverter, OBC, PDU) for xEVs
- Stationary EV charging stations
- Single phase and 3-phase UPS and VFD (Vac input for rectifier and Vdc input/battery)
- Industrial control panels and UL508A panel shops
- Energy storage and battery management systems
- High voltage power conversion (AC/DC, AC/AC, DC/DC, DC/AC)

#### **Environmental compliance**







#### Ordering part number

	AHCA-BM-1P	)
		-
Family name ———		
Terminal code ———		

#### **Packaging**

90 pieces in a tray, 10 trays (900 pcs) in a carton

#### Terminal code

• -1P

Copper with bright Nickel plating

· -PCBHT

Copper with bright Nickel plating



#### **Electrical characteristics**

Amp rating	1.5 In	2.0 In	3.0 In
	maximum	maximum	maximum
AHCA-BM	30 minutes	30 minutes	10 seconds

### **Product specifications**

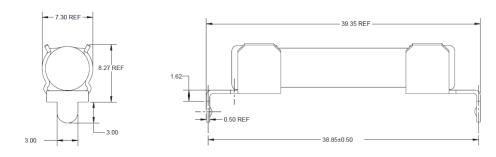
Part number	Current rating* (A)	Voltage rating (Vac)	Interrupting rating @ rated voltage (A)	Nominal cold resistance $(\Omega)$	
AHCA-BM	40	450	10,000	0.0029	

<sup>\*</sup> Carries 32 A for minimum of 4 hours at +85  $^{\circ}\text{C}$  .

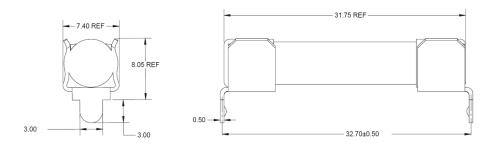
#### **Dimensions- mm**

Drawing not to scale

### AHCA-BM-1P



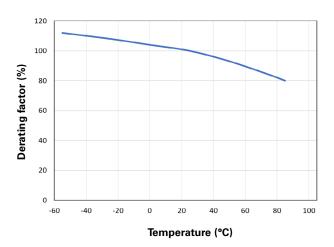
### **AHCA-BM-PCBHT**



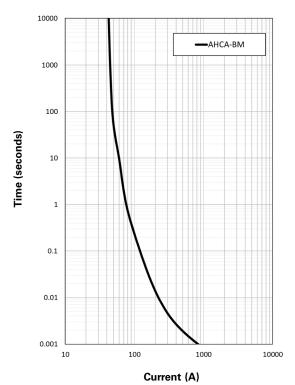
# **General specifications**

Operating temperature: -55 °C to +85 °C with proper correction factor applied
Terminal strength: MIL-STD-202G, Method 211A, Test Condition A, Pull force 10N/10S
Resistance to solder heat: MIL-STD202 Method 210, Condition B, temperature +260 ±5 °C for 10±1 s
Solderability: J-STD-002, No steam aging. Immersion conditions: +250 °C+/-3 °C, 3 s +/- 0.3 s

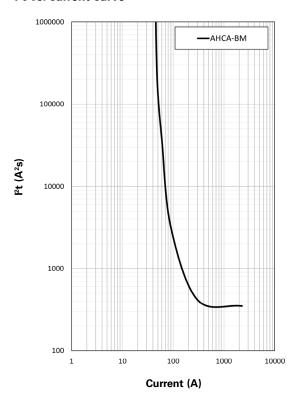
# Temperature derating curve



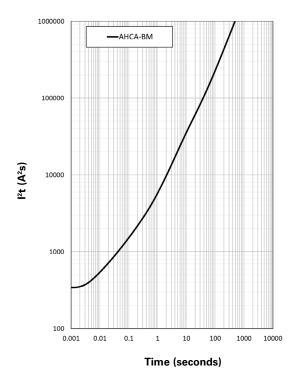
### Current vs. time curve



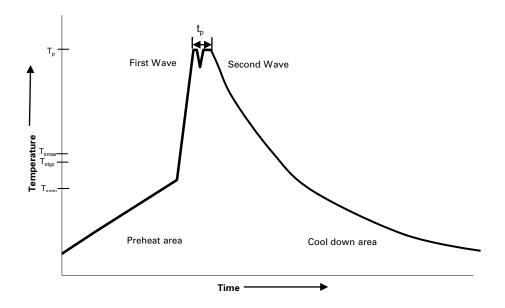
#### I<sup>2</sup>t vs. current curve



### l²t vs. time curve



#### Wave solder profile



#### Reference EN 61760-1:2006

Profile feature		Standard SnPb solder	Lead (Pb) free solder	
Preheat	• Temperature min. (T <sub>smin</sub> )	100 °C	100 °C	
	• Temperature typ. (T <sub>Styp</sub> )	120 °C	120 °C	
	• Temperature max. (T <sub>smax</sub> )	130 °C	130 °C	
	• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	70 seconds	70 seconds	
$\Delta$ preheat to	o max Temperature	150 °C max.	150 °C max.	
Peak tempera	ature (Tp)*	235 °C − 260 °C	250 °C – 260 °C	
Time at peak	temperature (t <sub>p</sub> )	10 seconds max 5 seconds max each wave	10 seconds max 5 seconds max each wave	
Ramp-down	rate	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	~ 2 K/s min ~3.5 K/s typ ~5 K/s max	
Time 25 °C to	o 25 °C	4 minutes	4 minutes	

#### Manual solder

+350 °C (4-5 seconds by soldering iron), generally manual/hand soldering is not recommended

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